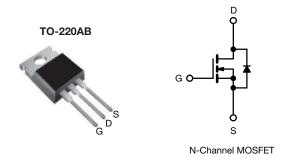
Vishay Siliconix

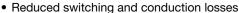
E Series Power MOSFET



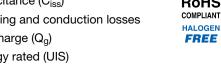
PRODUCT SUMMA	RY		
V _{DS} (V) at T _J max.	650)	
R _{DS(on)} typ. (Ω) at 25 °C	V _{GS} = 10 V	0.056	
Q _g max. (nC)	183	3	
Q _{gs} (nC)	27	•	
Q _{gd} (nC)	62		
Configuration	Single		

FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)



- Ultra low gate charge (Q_a)
- Avalanche energy rated (UIS)
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free and Halogen-free	SiHP38N60E-GE3

ABSOLUTE MAXIMUM RATINGS (T _C	, -				1	
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V_{DS}	600	V		
Gate-Source Voltage			V_{GS}	± 30	1 V	
Continuous Drain Current (T _{.I} = 150 °C)	V _{GS} at 10 V	$T_{\rm C} = 25 ^{\circ}{\rm C}$ $T_{\rm C} = 100 ^{\circ}{\rm C}$	_	43		
Continuous Drain Current (1) = 150 C)	V _{GS} at 10 V	T _C = 100 °C	I _D	27	Α	
Pulsed Drain Current ^a		I _{DM}	126]		
Linear Derating Factor				2.5	W/°C	
Single Pulse Avalanche Energy b			E _{AS}	614	mJ	
Maximum Power Dissipation			P _D	313	W	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to +150	°C		
Drain-Source Voltage Slope T _J = 125 °C		-0.77-11	100	V/ns		
Reverse Diode dV/dt ^d		dV/dt	13			
Soldering Recommendations (Peak temperature) c	Soldering Recommendations (Peak temperature) c For 10 s			300	°C	

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. $V_{DD} = 140 \text{ V}$, starting $T_J = 25 \,^{\circ}\text{C}$, $L = 28.2 \,\text{mH}$, $R_g = 25 \,\Omega$, $I_{AS} = 6.6 \,\text{A}$
- c. 1.6 mm from case
- d. $I_{SD} \le I_D$, $dI/dt = 100 \text{ A/}\mu\text{s}$, starting $T_J = 25 \,^{\circ}\text{C}$



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THERMAL RESISTANCE RATI	NGS			
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R _{thJA}	-	62	°C/W
Maximum Junction-to-Case (Drain)	R _{thJC}	-	0.4	G/VV

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static		_		l		•	
Drain-Source Breakdown Voltage	V_{DS}	V _{GS} :	= 0 V, I _D = 250 μA	600	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 1 mA	-	0.72	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μA	2.0	-	4.0	V
Coto Courso Lockego			V _{GS} = ± 20 V	-	-	± 100	nA
Gate-Source Leakage	I _{GSS}		V _{GS} = ± 30 V	-	-	± 1	μΑ
Zara Cata Valtaga Drain Current	1	V _{DS} =	= 600 V, V _{GS} = 0 V	-	-	1	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 480 \	/, V _{GS} = 0 V, T _J = 125 °C	-	-	10	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 19 A	-	0.056	0.065	Ω
Forward Transconductance	9 _{fs}	V _{DS}	= 30 V, I _D = 19 A	-	11	-	S
Dynamic					-	•	
Input Capacitance	C _{iss}	V _{GS} = 0 V,		-	3600	-	pF
Output Capacitance	C _{oss}	7	$V_{DS} = 0 \text{ V},$ $V_{DS} = 100 \text{ V},$		177	-	
Reverse Transfer Capacitance	C _{rss}	f = 1 MHz		-	5	-	
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	$V_{DS} = 0 V \text{ to } 480 V, V_{GS} = 0 V$		-	115	-	
Effective Output Capacitance, Time Related ^b	C _{o(tr)}			-	587	-	
Total Gate Charge	Q_g			-	122	183	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	$I_D = 19 A, V_{DS} = 480 V$	-	27	-	nC
Gate-Drain Charge	Q _{gd}	1		-	62	-	
Turn-On Delay Time	t _{d(on)}			-	33	66	
Rise Time	t _r	V_{DD} = 480 V, I_{D} = 19 A, V_{GS} = 10 V, R_{g} = 9.1 Ω		-	58	87	ns
Turn-Off Delay Time	t _{d(off)}			-	116	174	
Fall Time	t _f			-	50	75	
Gate Input Resistance	R _g	f = 1 MHz, open drain		0.3	0.6	1.2	Ω
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET sym	MOSFET symbol showing the		-	42	
Pulsed Diode Forward Current	I _{SM}	integral reverse p - n junction diode		-	-	126	- A
Diode Forward Voltage	V _{SD}	T _J = 25 °0	C, I _S = 19 A, V _{GS} = 0 V	-	-	1.2	V
Reverse Recovery Time	t _{rr}	0 7 0 7 - 100 1		-	491	1582	ns
Reverse Recovery Charge	Q _{rr}		$T_J = 25 ^{\circ}\text{C}, I_F = I_S = 19 \text{A},$		8.4	16.8	μC
Reverse Recovery Current	I _{RRM}	dl/dt = 100 A/ μ s, V _R = 25 V		_	26	-	A

Notes

- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}
- $b. \ \ C_{oss(tr)} \ is \ a \ fixed \ capacitance \ that \ gives \ the \ same \ charging \ time \ as \ C_{oss} \ while \ V_{DS} \ is \ rising \ from \ 0 \ \% \ to \ 80 \ \% \ V_{DSS} \ is \ rising \ from \ 0 \ \% \ to \ 80 \ \ t$



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

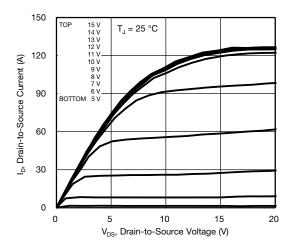


Fig. 1 - Typical Output Characteristics

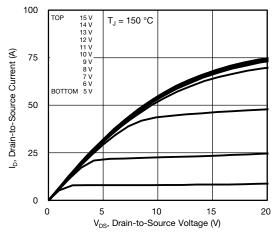


Fig. 2 - Typical Output Characteristics

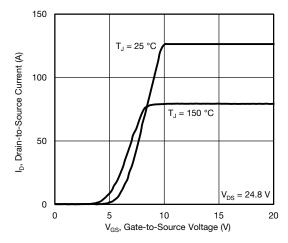


Fig. 3 - Typical Transfer Characteristics

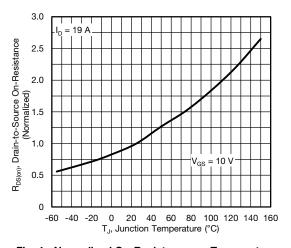


Fig. 4 - Normalized On-Resistance vs. Temperature

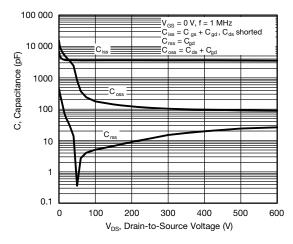


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

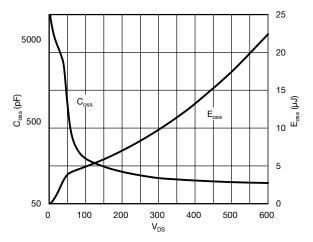


Fig. 6 - Coss and Eoss vs. VDS



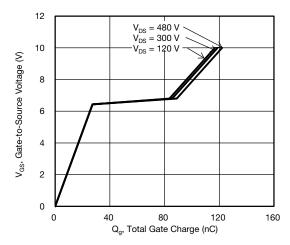


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

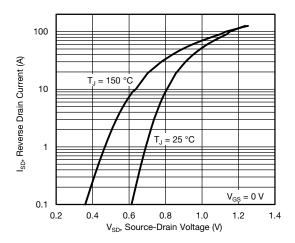


Fig. 8 - Typical Source-Drain Diode Forward Voltage

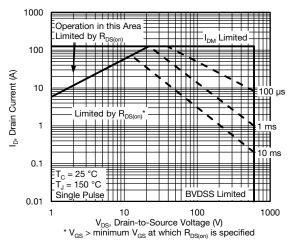


Fig. 9 - Maximum Safe Operating Area

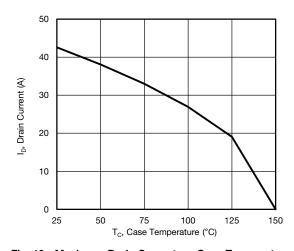


Fig. 10 - Maximum Drain Current vs. Case Temperature

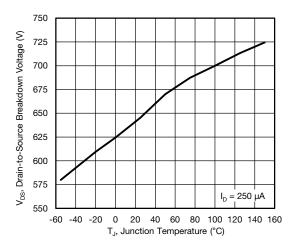


Fig. 11 - Temperature vs. Drain-to-Source Voltage



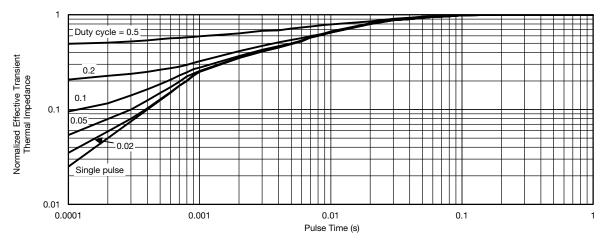


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

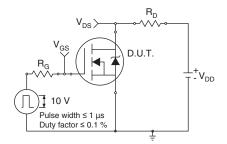


Fig. 13 - Switching Time Test Circuit

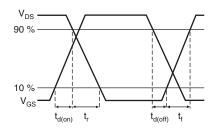


Fig. 14 - Switching Time Waveforms

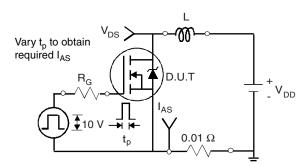


Fig. 15 - Unclamped Inductive Test Circuit

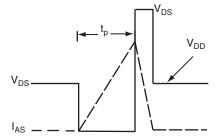


Fig. 16 - Unclamped Inductive Waveforms

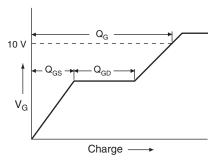


Fig. 17 - Basic Gate Charge Waveform

Current regulator Same type as D.U.T

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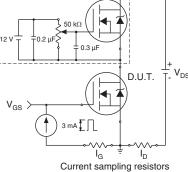
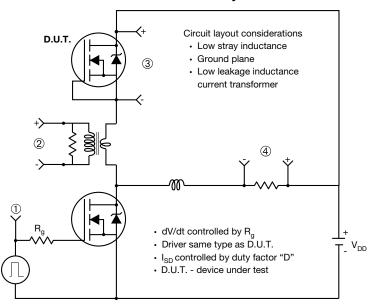


Fig. 18 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



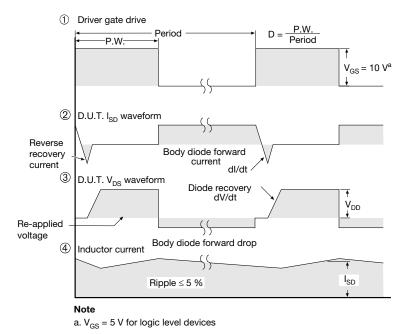
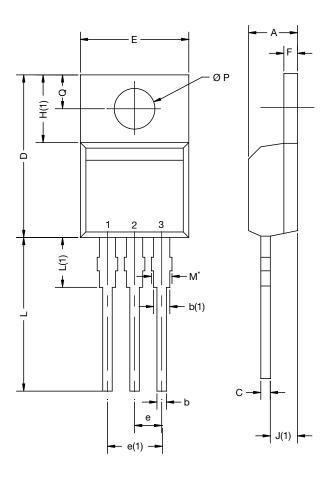


Fig. 19 - For N-Channel

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TO-220-1



DIM.	MILLIN	IETERS	INCHES		
	MIN.	MAX.	MIN.	MAX.	
Α	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
E	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØP	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	

Note

• $M^* = 0.052$ inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



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Vishay

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